

System-on-Chip Market by Type (Digital, Analog, and Mixed Signal) and Application (Consumer Electronics, Telecommunication, and Automotive) - Global Opportunity Analysis and Industry Forecast, 2017-2023

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Abstracts

System-on-chip (SoC) is a microchip on which the components are integrated on a single chip. These components include controllers, timing units, memory units, transistors, peripherals, and more depending upon the type of application. SoC includes both software as well as the hardware, which is mounted in various electronic devices such as tablets and mobile phones. SoCs have witnessed the highest adoption in the electronics industry, as they are power efficient and compact in nature.

Increase in demand for smart and power-efficient electronic devices, high adoption rate of IoT, and compact feature of SoC supplement the market growth. However, high initial cost of design & development and maintenance impedes the growth.

The global system-on-chip market is segmented based on type, application, and region. Based on type, the market is divided into digital, analog, and mixed signal. The applications discussed in this study are consumer electronics, telecommunication, and automotive. Furthermore, based on region, the market is analyzed across North America, Europe, Asia-Pacific, and LAMEA.

Key players operating in the market are Intel Corporation, Samsung Electronics Co. Ltd., Qualcomm Incorporated, Toshiba Corporation, NXP Semiconductors N.V., Broadcom Limited, STMicroelectronics N.V., Apple Inc., MediaTek Inc., and Taiwan Semiconductor Manufacturing Company Limited.

KEY BENEFITS FOR STAKEHOLDERS

This study comprises analytical depiction of the global system-on-chip market

with current trends and future estimations to depict the imminent investment pockets.

The overall market potential is determined to understand the profitable trends to gain a stronger coverage in the market.

The report presents information related to key drivers, restraints, and opportunities with a detailed impact analysis.

The current market is quantitatively analyzed from 2017 to 2023 to highlight the financial competency of the market.

Porter's Five Forces analysis illustrates the potency of the buyers and suppliers.

KEY MARKET SEGMENTS

BY TYPE

Digital

Analog

Mixed Signal

BY APPLICATION

Consumer electronics

Telecommunication

Automotive

BY REGION

North America

U.S.

Canada

Mexico

Europe

UK

Germany

France

Rest of Europe

Asia-Pacific

China

Japan

India

Australia

Rest of Asia-Pacific

LAMEA

Latin America

Middle East

Africa

KEY MARKET PLAYERS PROFILED

Intel Corporation

Samsung Electronics Co. Ltd.

Qualcomm Incorporated

Toshiba Corporation

NXP Semiconductors N.V.

Broadcom Limited

STMicroelectronics N.V.

Apple Inc.

MediaTek Inc.

Taiwan Semiconductor Manufacturing Company Limited

Magna International Inc.

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